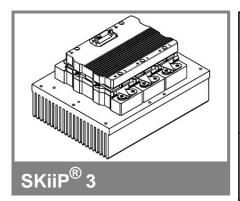
SKiiP 1513GB172-3DL



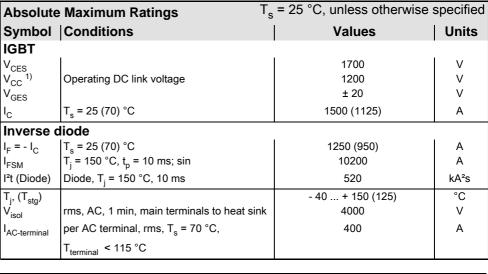
2-pack-integrated intelligent Power System

Power section SKiiP 1513GB172-3DL

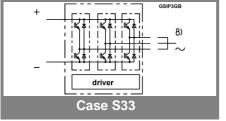
Data

Power section features

- SKiiP technology inside
- Trench IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated teperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 3 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal
- 8) AC connection busbars must be connected by the user; copper busbars available on request



Characte	Characteristics			$T_s = 25$ °C, unless otherwise specified			
Symbol	Conditions			min.	typ.	max.	Units
IGBT							
V _{CEsat}	I _C = 900 A, T _j = 25 (1) measured at terminal	125) °C;			1,9 (2,2)	2,4	V
V_{CEO}	$T_i = 25 (125) ^{\circ}C; at t$	erminal			1 (0,9)	1,2 (1,1)	V
r _{CE}	$T_i = 25 (125) ^{\circ}\text{C}$; at t				1 (1,4)	1,3 (1,7)	mΩ
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = V_{C}$ $T_{i} = 25 (125) \text{ °C}$	ES [,]			3,6 (216)		mA
$E_{on} + E_{off}$	$I_{\rm C}^{\rm J}$ = 900 A, $V_{\rm CC}$ = 90	0 V			585		mJ
	$T_j = 125 ^{\circ}\text{C}, V_{CC} = 1.$	200 V			863		mJ
R _{CC+EE}	terminal chip, T _j = 25	5 °C			0,17		mΩ
L_{CE}	top, bottom				4		nΗ
C _{CHC}	per phase, AC-side				5,1		nF
Inverse o							
$V_F = V_{EC}$	I _F = 900 A, T _j = 25 (1 measured at terminal	25) °C			2 (1,8)	2,15	V
V_{TO}	T: = 25 (125) °C				1.1 (0.8)	1,2 (0,9)	V
r _T	T _j = 25 (125) °C T _j = 25 (125) °C				1 (1,1)	1,1 (1,2)	mΩ
E _{rr}	$I_{\rm C}^{\rm J}$ = 900 A, $V_{\rm CC}$ = 90	0 V			108		mJ
	$T_j = 125 ^{\circ}\text{C}, V_{CC} = 1.$	200 V			128		mJ
Mechani	cal data						•
M_{dc}	DC terminals, SI Uni	ts		6		8	Nm
M_{ac}	AC terminals, SI Uni			13		15	Nm
W	SKiiP® 3 System w/c	heat sink			2,4		kg
W	heat sink				7,5		kg
	characteristics (
	e to heat sink; "r	" reterei	nce to bu	uiit-in te	mperature	e sensor ((acc.IEC
60747-15	per IGBT			İ		0,02	K/W
R _{th(j-s)I}	per diode					0,02	K/W
$R_{th(j-s)D}$	R; (mK/W) (max. values) tau;(s)						
← th	1 2	3	4	l 1	2	i ⁽³⁾	4
$Z_{\text{th(j-r)I}}$	3,4 9,6	7	0	363	0,18	0,04	1
_"'\(J^-1)'	1				•		



 $Z_{\text{th(j-r)I}}$ $Z_{\text{th(j-r)D}}$

 $Z_{th(r-a)}$

12

2,1

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20

1,4

30

210

5

85

0,25

0,04

0,4

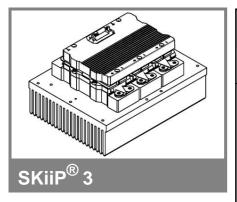
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20

18

5,5

SKiiP 1513GB172-3DL



2-pack-integrated intelligent Power System

2-pack integrated gate driver SKiiP 1513GB172-3DL

Data

Gate driver features

- · CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and

DC-bus voltage (option)

- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 40/85/56
- UL recognized file no. 242581

Absolute	Maximum Ratings T _a	_a = 25 °C, unless otherwise specified		
Symbol	Conditions	Values	Units	
V_{S2}	unstabilized 24 V power supply	30	V	
V_{i}	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
V_{isollO}	input / output (AC, rms, 2 s)	4000	V	
V _{isoIPD}	partial discharge extinction voltage, rms, $Q_{PD} \le 10 \text{ pC}$;	1500	V	
V _{isol12}	output 1 / output 2 (AC, rms, 2 s)	1500	V	
f _{sw}	switching frequency	9	kHz	
f _{out}	output frequency for I _{peak(1)} =I _C	9	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 + 85	°C	

Characteristics			(T _a = 25 °		
Symbol	Conditions	min.	typ.	max.	Units
V_{S2}	supply voltage non stabilized	13	24	30	V
I _{S2}	V _{S2} = 24 V	380+34*f/kHz+0,00015*(I _{AC} /A) ²		mA	
V _{iT+}	input threshold voltage (High)			12,3	V
V_{iT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance		10		kΩ
C _{IN}	input capacitance		1		nF
t _{d(on)IO}	input-output turn-on propagation time		1,3		μs
t _{d(off)IO}	input-output turn-off propagation time		1,3		μs
t _{pERRRESET}	error memory reset time		9		μs
t_{TD}	top / bottom switch interlock time		3,3		μs
I _{analogOUT}	max. 5 mA; 8 V corresponds to 15 V supply voltage for external components		1500		Α
I _{s1out}	max. load current			50	mA
I _{TRIPSC}	over current trip level				
	(I _{analog} OUT = 10 V)		1875		Α
T_tp	over temperature protection	110		120	°C
U _{DCTRIP}	U _{DC} -protection (U _{analog OUT} = 9 V);		not implemented	t	V
	(option for GB types)				

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